# Inductor Radial Leaded

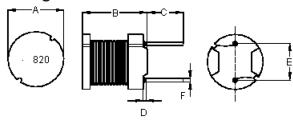
### multicomp PRO





**Top View** 

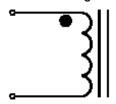
### **Configurations and Dimensions**



**Front View** 

Note: White dot of marking indicates the start terminal of winding

### Schematic Diagram



Note:

- 1. Wire UEFN/U (155°C) Ø0.35mm
- 2. 51.5TS (Reference) C.W

### **Test Data for Mechanical**

Test Item	A mm	B mm	C mm	D mm	E mm	F mm
Specification	7.8 ±0.5	9.5 ±0.5	5 ±1	3 (Max.)	5 ±0.5	Ø0.7 (Ref.)
1	7.74	9.4	5.23	1.54	5.21	0.63
2	7.74	9.47	5.26	1.57	5.16	0.62
3	7.73	9.43	5.31	1.56	5.14	0.64
4	7.75	9.47	5.27	1.53	5.09	0.62
5	7.76	9.48	5.3	1.51	5.17	0.63
Average	7.74	9.45	5.27	1.54	5.15	0.63

**Bottom View** 

#### **Electrical Characteristics**

Test Condition		
1kHz 0.25V	L	82μH ±10%
T <sub>A</sub> = 25°C	DCR	155mΩ ±20%
1kHz 0.25V Irms = 1.6A	ΔΤ	Temperature rise 40°C (Max.)

Operating temperature : -55°C to +130°C

### **Material List**

No.	Item	Item Material Description		
1	Core	F4F DR2W7.8 × 9.5 (SW) RCH B3.6 F5.4 P5		
2	Wire	Ø0.35mm UEFN/U (155°C)		
3	Solder (Lead-free)	Sn99.3% / Cu0.7%		

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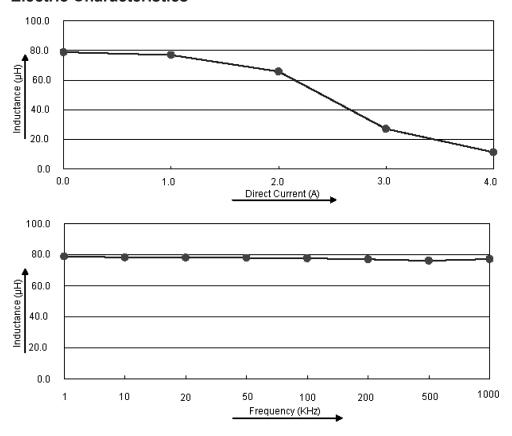
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### **Reliability Test**

Test Item	Specifications		Test Method and Remarks		
Operating temperature range	-55°C to +130°C		Including temperature r	ise due to self-generated heat.	
Storage condition	Ambient temperature : 0°C to 40°C Humidity : Below 70% RH		To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in the storage area.		
Moisture sensitivity	Appearance  DCR change Inductance change	: No abnormality No damage : Within ±5% : Within ±5%	According to J-STD-02 Test condition Test duration Recovery	OB level 3 : 60°C 60% RH : 40 hrs : 1 to 2 hours of recovery under the standard condition after the removal from the test chamber.	
Solderability	All termination shall exhibit a continuous solder coating free from defects for a minimum of 95% of the surface area of any individual lead.		According to J-STD-00. Steam aging category Steam aging duration Solder Solder temperature Dip time	: 97°C 98% RH	

### **Electric Characteristics**



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#### **Test Data for Electrical**

Test Item	L µH	DCR mΩ	ΔΤ
Condition	1kHz 0.25V	at 25°C	1kHz 0.25V Irms = 1.6A
Specification	82 ±10%	155 ±20%	Temperature rise 40°C (Max.)
1	79.2	157.12	
2	78.86	154.81	
3	78.76	156.22	OK
4	78.82	153.99	
5	79.04	154.99	
Average	78.94	155.43	ОК

#### **Part Number Table**

Description	Part Number	
Inductor, 82µH, 10%, Radial Leaded	MCSCH895-820KU	

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